THE UNIVERSITY OF HONG KONG

香 港

I wish to apply for deferment of repayment of the following loan(s) –

Others (please specify)

(iv)





Repayment

Amount outstanding



Campus Life 校園生活

APPLICATION FOR DEFERMENT OF UNIVERSITY FINANCIAL ASSISTANCE LOAN REPAYMENT (DUE TO FULL-TIME STUDIES)

Next due date Name of Loan Fund Amount awarded Year amount overdue but not yet due (if any) awarded and last due date * * please enter "nil" if you do not have any overdue repayment Part A Personal Particulars Full name in English: Residential address: Residential telephone no.: Mobile no.: Email address: Correspondence address (if different from the above resident address): Date of graduation/leaving the institution (month/year): ______ Course of study: _____ Part B Particulars of your Full-time Studies Institution: Name of full-time course: Qualification to be obtained: ___ Earliest expected date of graduation (month / year): Breakdown of expenses to be incurred for your further studies -Item Amount (per annum) (i) **Tuition Fees** (ii) Boarding fees (iii) Travelling expenses

Centre of Development and Resources for Students 學生發展及資源中心

Source(s) of financial support for your studies:

Part C	
I hereby declare that the information stated above is true and correct.	
Signature of applicant:	
Date:	

Please submit the following documentary proofs with this application –

- (i) A copy of the admission letter or other supporting document issued by the institution certifying your being a full-time student and your earliest expected date of graduation;
- (ii) A copy of your student identity card with expiry date printed on it and/or a receipt for payment of tuition fees;
- (iii) A copy of your student visa and/or passport which indicated permission to enter a country (if appropriate). The document should also indicate the approved duration of stay.

We may approach you for further information, if necessary.

Jan 2020